

REMARKS

With the above amendments, the specification has been amended to incorporate the International and Japanese priority applications by reference, and to improve punctuation, spelling and grammar. The claims have been amended to place them in better form for examination. The Abstract of the Disclosure and the Drawings have been amended to comply with formal requirements of the United States Patent and Trademark Office (USPTO).

A substitute specification in compliance with 37 C.F.R. §1.125 is attached. The attached substitute specification contains no new matter.

Accordingly, it is believed that the application is in good condition for examination. The below-signed attorney for Applicants welcomes any questions.

Respectfully submitted,

GRIFFIN & SZIPL, P.C.



Joerg-Uwe Szipl
Registration No. 31,799

GRIFFIN & SZIPL, P.C.
Suite PH-1
2300 Ninth Street, South
Arlington, VA 22204

Telephone: (703) 979-5700
Facsimile: (703) 979-7429
Email: GandS@szipl.com
Customer No.: 24203

AMENDMENTS TO THE DRAWINGS:

The attached three (3) sheets of drawings include changes to Figures 17 to 20. These three sheets include Figures 16 to 20. Figures 17 to 20 have been labeled as "Prior Art" in accordance with MPEP § 608.02(g).

Attachments: Three Replacement Sheets

SPECIFICATION

VACUUM THERMAL INSULATING VALVE

[0000] This is a National Phase Application in the United States of

5 International Patent Application No. PCT/JP2005/000265 filed January 13, 2005,
which claims priority on Japanese Patent Application No. JP 2004-014032, filed
January 22, 2004. The entire disclosures of the above patent applications are
hereby incorporated by reference.

10 Field of the Invention

[0001] The present invention is concerned with improvements in a vacuum thermal insulating valve employed in a pipe passage for a gas supply system, or a gas exhaust system, mainly in semiconductor manufacturing facilities or chemical plants.

15

Background of the Invention

[0002] With ~~at~~ the gas supply system with which the liquefied gas is vaporized, it has been conventionally practiced ~~to heat~~ that the pipe passage is heated to more than a specified temperature to prevent the supply gas from re-condensing in the pipe passage. Similarly, ~~also with~~ ~~at~~ the gas exhaust system in semiconductor manufacturing facilities, plasma generating apparatuses and the like, the pipe passages, valve devices mounted thereon, and the like, have been heated to prevent the exhaust gas from forming gas condensation in the pipe passage.

20

[0003] For example, the internal pressure of a process chamber for semiconductor manufacturing facilities can be kept evacuated to approximately 10^{-4} to 10^2 torr, depending on the type of the process, by making the exhaust side of the chamber ~~being~~ continuously exhausted by a vacuum pump.

5 ~~On the other hand, due to the reason that~~ necessary treatments are performed by using various kinds of corrosive gases or toxic gases, a large

~~1~~

amount of corrosive gases, and the like, are found in the exhaust gases passing
10 through the exhaust system.

~~Accordingly, for an~~ exhaust system for the process chamber, condensation of the corrosive gas is prevented by heating pipe passages or valve units; thus, the devices constituting the exhaust system are prevented from corrosion because corrosive effects are substantially increased
15 when corrosive gases liquefy due to condensation.

[0005] Also, with semiconductor manufacturing facilities, it ~~is~~ strongly desired that the entire unit, including the exhaust system of the process chamber, be further downsized. Therefore, for the vacuum exhaust system of the process chamber, it is also strongly desired to make small the diameter of the
20 exhaust pipe passage, downsize of the vacuum exhaust pumps, downsize of valves to be employed, and the like ~~are also strongly desired~~, and ideas to realize these desires have been studied. Particularly, for the vacuum exhaust system, more efforts has been made ~~have been put~~ further to further downsize the pipe passages and valves by enhancing their thermal

insulating performance.

[0006] With regard to the pipe passages of the vacuum exhaust system in semiconductor manufacturing facilities and the like, the initial objective has been nearly ~~achieved~~attained by employing a vacuum thermal insulating pipe passage.

However, with regard to a valve unit ~~that~~which constitutes a vacuum exhaust system, there remain many unsolved ~~problems~~difficulties such as thermal insulating capabilities, downsizing, energy-saving and the like.

[0007] Though the explanation ~~is given here~~ is with regard to ~~the problems~~ _

~~-2-~~

related to the vacuum exhaust system for semiconductor manufacturing facilities, ~~it goes without saying~~there is no need to say, however, that ~~such~~these problems have some similarities with the problems ~~of~~with the gas supply system on the upstream side, and the gas supply system or gas exhaust system in other chemical apparatuses, and the like. Accordingly, the gas supply system, exhaust system for semiconductor manufacturing facilities, and the like, are used as examples to explain these ~~problems as follows~~difficulties hereunder.

[0008] A so-called "unit-type valve" V₁ constituted as shown in Figure 17 to Figure 20, has been widely used for semiconductor manufacturing facilities and the like to make a valve ~~that~~ is itself small and compact. For example, the unit-type valve V shown in Figure 17 and Figure 18 has outer dimensions of 150~500mm in breadth, 130~150mm in height, and 80~100 in depth. In particular

Namely, the valve V is made of a valve unit body V₁ formed by

combining a plural number of valve bodies V_{10} , V_{20} ..., and actuators D mounted on the valve bodies V_{10} , V_{20} ..., respectively. The valve itself, as a unit, is a metal diaphragm type valve comprising the valve body V_{10} and the actuator D .__

_____The afore-mentioned valve V is heated to normally approximately 5 150°C by a heater (not illustrated) to prevent corrosive gases passing through the inside from condensing~~being condensed~~.

[0009] The heated valve V is of a very compact structure, and its temperature is held at less than a~~the~~ temperature (approximately 40°C) that allows it to~~so~~ it can be touched by hands from the outside. And, heated valve V ~~it~~ needs 10 thermal insulation so that ~~the~~ leakage of heat directly to the outside is prevented.

~~3~~

In the case where rock wool is used as a thermal insulating material, the thickness of the wool needed for one side will be 30 to ~50mm, thus making it difficult to that it~~is~~ compact-sized the valve V .

15 [0010] Similarly, in the case where ~~the~~a valve V is made to be enclosed by a pneumatic thermal insulation type box body (equipped with a silver-plated layer to suppress heat transfer by radiation on the inner wall surface and made with an~~the~~ air layer of~~to~~ be 10mm) of a double wall structure, it was ~~found difficult to~~ reduce~~that~~ the temperature of the outer surface of the thermal insulating box 20 ~~was reduced to~~ less than approximately 40°C because of ~~the~~ heat transfer by convection of the air layer.

[0011] Therefore, first, the inventors of the present invention developed a vacuum thermal insulating valve, which was made to house a valve unit body V_1 of the valve inside a~~the~~ vacuum thermal insulating box S_1 by making use of

vacuum thermal insulation as shown in Figure 21. It was learned, however, that ~~the vacuum thermal insulating valve in Figure 21~~ it was not commercially practical ~~because with the vacuum thermal insulating valve in Figure 21~~ due to the reason that the temperature of the outer surface (i.e., the surface temperature of the actuator in the center part) became higher than the specified temperature (40°C) by any means.

[0012] Therefore, inventors of the present invention formed a vacuum thermal insulating box S made by combining 3 vacuum jackets S₁, S₂, S₃ as shown in Figure 22 to ~Figure 25, and conducted various kinds of tests using this box.

~~In~~ With Figure 22 to ~Figure 25, the main reasons why the vacuum thermal insulating box S is divided into 3 vacuum jackets S₁, S₂, S₃, or the first, second and third vacuum jackets, are that a vacuum thermal insulating pipe receiving -

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part J can be easily fabricated and also that the distance of the solid heat transfer distance can be made longer this way. In

With Figure 22 to ~Figure 25, K designates a silicon sponge-made thermal insulating layer (thickness t = 2mm), H a plane heater, G a getter case, J a vacuum thermal insulating pipe receiving part, O a seal-off valve, Q a cable takeout opening, and OUT and IN are temperature measuring points.

Furthermore, in with Figure 22 to ~Figure 25, a 2mm-thick stainless steel plate is used for the metal plate that which constitutes vacuum jackets S₁, S₂, S₃. The entire inner wall faces of the vacuum jackets S₁ to ~S₃ are given electroless Ag plating, and then a vacuum heating treatment of 550°C x 2hrs is

conducted on ~~the~~ said silver plating layer to enhance its emissivity.

[0013] With Figure 25, ~~there are shown other~~ temperature measuring points are shown beside temperature measuring points IN and OUT in the afore-shown Figure 22 ~~to~~ Figure 24. Figure 26 and Figure 27 show the results of temperature measurements at each measuring point of the first vacuum jacket S₁ and the second vacuum jacket S₂.

[0014] On the other hand, the thermal insulating performance of 2 vacuum thermal insulating boxes S can be ~~demonstrated~~ presented by the electric power required to hold the inside of the vacuum thermal insulating boxes S at the specified temperature used for comparison ~~being compared~~.

———First, the inventors of the present invention made adjustable the voltage to be applied to a plane heater H (100V·200W·50Ω x 2 pieces), and at the time when the temperature of the valve unit body V₁ reached equilibrium (approx. 3_—
—5—

hours later ~~after the start of heating~~), power consumption was measured both under conditions ~~at the time~~ when the vacuum thermal insulating box S was inserted, and the vacuum thermal insulating box S was not inserted, respectively.

[0015] It ~~was~~ has been learned that while input power was 81W (stabilized at in 150°C at 45V, thus input power $W = 45^2 / 50 \times 2 = 81W$) when the vacuum thermal insulating box S was inserted, input power was 213W (stabilized at in 150°C at 73V, thus input power $W = 73^2 / 50 \times 2 = 213W$) when the vacuum thermal insulating box S was not inserted. These results revealed that input power can be reduced to 81/213 owing to the thermal insulating performance of the vacuum

thermal insulating box S.

[0016] Consumption power W_1 with which the thermal insulating performance of the afore-mentioned vacuum insulating box S is estimated, can be calculated by the operating time and operating voltage of the relay of the temperature controller that supplies supply power to the plane heater H because the supply power supplied to the plane heater H is proportional to the output voltage of the relay of the temperature controller. T, and thus, supply power to the plane heater H can be determined by measuring the output voltage and output time of the relay of the temperature controller with an the oscillogram, and by obtaining the peak area (the peak integration value) by making use of the integration function of the peak area of the oscillogram. Specifically

————Namely, because the afore-mentioned peak area (a peak integration value) is equal to the output voltage x output time, it is can be determined that the output time = the peak integration value/the output voltage, and the output % = -

~~6~~
the-output time x 100/ the measuring time = the peak integration value x 100/(the measuring time x the output voltage).

[0017] For example, ~~new~~ assuming that the output voltage of the relay of the temperature controller is 12V and the measuring time 50 seconds, it is can be determined that the output % = the peak integration value x 100/(12x50) = the peak integration value/6.

[0018] According to the test results, the peak integration value (the average of 5 points) of the oscillogram at the time when the temperature of the valve unit body V₁ was in a stable state at 150°C, with the vacuum thermal insulating box S

being inserted, was 119.0 (V · sec) taking ~~the~~an average. Accordingly, the output % at this time becomes $119/6 = 19.83\%$. With ~~a~~the rated capacity of the plane heater H ~~of~~is 400W, the output of the plane heater H becomes $400W \times 19.83\% = 79.3W$.__

5 ———The peak integration value (the average of 5 points) of the oscillogram at the time when the temperature of the valve unit body V₁ was in a stable state at 150°C, with the vacuum thermal insulating box S being removed, was 331.6 (v · sec). Accordingly, the output % at this time becomes $331.6/6 = 55.27\%$. Thus, the output of the plane heater H becomes $400W \times 55.27\% = 221.1W$.

10 [0019] When the input power ratio (the case ~~where~~that the vacuum thermal insulating box was in use/the case ~~where~~that the vacuum thermal insulating box was not in use = 81/213) determined by the afore-mentioned voltage adjustment is compared with the output power ratio (79.3/221.1) determined by the peak integration value on the oscillogram, it ~~was~~is learned that there exists almost no
15 difference_—

~~7~~

between them.__

———Because ~~the~~ thermal insulating performance of ~~a~~the vacuum thermal insulating box S can be measured easier with the former method, ~~wherein~~with
20 ~~which~~ the input voltage to the plane heater H is adjusted, ~~for~~with the embodiments of the present invention, the verification test for the vacuum insulating characteristics is conducted ~~using~~by the method of adjusting ~~the~~said input voltage.

[0020] In ~~the~~ case ~~where~~that the vacuum insulating box S, according to the

combination of 3 vacuum jackets S₁, S₂, S₃ is used as shown in Figure 22 to ~Figure 25, the thermal insulating performance expressed by the ratio of input voltage to the plane heater H is 81/213, which is not a sufficient performance ~~is found to be not sufficient~~.

- 5 [0021] Another problem encountered is that the thermal insulating performance is lowered because thesaid vacuum thermal insulating box S in Figure 22 to ~Figure 25 is structured by combining 3 segments, which leads to high thermal conductivity by ~~the~~ solid heat transfer.

- 10 [0022] Furthermore, another problem with the afore-mentioned vacuum thermal insulating box S shown in Figure 22 to ~Figure 25 is that, because a 2mm-thick stainless steel plate is employed from the view point of providing its mechanical strength, ~~the~~ thermal conductivity by ~~the~~ solid heat transfer becomes relatively high.

[0023] Patent Document: TOKU-KAI-SHO No.61-262295 Public Bulletin

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Disclosure of the Invention

Object of the Invention

[0024] It is a primary object of the present invention to solve the _-

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- 20 afore-mentioned problems with a vacuum thermal insulating box S, which basic development was performed by inventors of the present invention, as shown in Figure 22 to ~Figure 25, that hasis, (a) insufficient thermal insulating performance, (b) a substantial decrease in the thermal insulating performance by solid heat transfer due to the reason that 3 segments are combined.

Another primary object of the present invention is, and to provide a vacuum thermal insulating valve ~~that~~which is small-sized and equipped with the high thermal insulating performance, and is made by combining a jacket-type vacuum thermal insulating box S with ~~the~~ better thermal insulating performance by using

5 2 vacuum jacket segments and a valve V.

Summary of the Invention~~Means to Achieve the Object~~

[0025] The present invention in accordance with a first embodiment~~as claimed in Claim 1~~ is fundamentally ~~so~~ constituted so that, with the vacuum thermal

10 Insulating valve formed by a valve equipped with a valve body and an actuator, and a vacuum thermal insulating box ~~that~~which houses ~~this~~said valve, the afore-mentioned vacuum thermal insulating box S comprises a square-shaped lower vacuum jacket S₅ equipped with a cylinder-shaped vacuum thermal insulating pipe receiving part on its side, and also with an upper face ~~that~~which is
15 made open, and a square-shaped upper vacuum jacket S₄ hermetically fitted to ~~the~~said lower vacuum jacket S₅ from the above, and also with a lower face ~~that~~which is made open; and the jointed part 2d' is formed by bending the inner wall 8b and the outer wall 8a' of the upper end of the afore-mentioned lower vacuum jacket S₅ toward the inside in the shape of a brim, and also the jointed
20 part 2d is formed by bending the center part of the height _

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direction of the side of ~~the~~said lower vacuum jacket S₅ toward the outside in the shape of a brim, and further the jointed part 2c is formed by bending the inner wall 7b and the outer wall 7a of the lower end of the afore-mentioned upper

vacuum jacket S4 toward the outside in the shape of a brim, and ~~the both~~ are combined in ~~a~~the manner that the vacuum thermal insulating side wall of the upper vacuum jacket S4 is positioned toward the outside of the vacuum thermal insulating side wall of the afore-mentioned lower vacuum jacket S5, to make the
5 jointed part 2c of the lower end of the afore-mentioned ~~upper vacuum jacket S4~~ and the jointed part 2d of the outer wall side of the lower vacuum jacket S5 hermetically ~~sealed~~~~contacted~~ by installing a thermal insulating material layer K, and also to make the jointed part 2d' of the inner wall 7b of the ceiling part of the upper vacuum jacket S4 and the upper end of the lower vacuum jacket S5
10 hermetically ~~sealed~~~~contacted~~ by installing a thermal insulating material layer K.

[0026] The present invention in accordance with a second embodiment ~~modifies the first embodiment as claimed in Claim 2 according to Claim 1 is so~~ ~~made so~~ that ~~the~~a valve V is equipped with a valve unit body V1 made by a plural number of valve bodies V10, V20 ... ~~that are~~being integrally connected.

15 [0027] The present invention in accordance with a third embodiment ~~modifies the first embodiment as claimed in Claim 3 according to Claim 1 is so made so~~ that a heater H is mounted on ~~the~~a valve body, and ~~the~~said heater H is made to be a plane heater fixed to the valve body.

20 [0028] The present invention in accordance with a fourth embodiment ~~modifies the first embodiment as claimed in Claim 4 according to Claim 1 is so constituted so that~~ ~~the~~a valve body ~~has ante~~ ~~to which~~ outer surface ~~to which~~ a plane heater H is fixed and ~~with which~~an inner part equipped with a valve seat and a valve seat part ~~are~~equipped.

[0029] The present invention in accordance with a fifth embodiment ~~modifies~~

~~the first embodiment as claimed in Claim 5 according to Claim 1 is so~~

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~~made so~~ that ~~the~~a thermal insulating material layer K is made of a silicon sponge.

5 [0030] The present invention in accordance with a sixth embodiment modifies

~~the first embodiment as claimed in Claim 6 according to Claim 1 is so made so~~

that the outer wall 7a of the upper vacuum jacket S₄ is 2mm thick and its inner wall 7b is 1.5mm thick, and the inner wall 8b of the lower vacuum jacket S₅ is 2mm thick and the lower part 8a of its outer wall is 2mm thick and the upper part

10 8a' of the side wall of the outer wall is 1.5mm thick, and each wall is~~they are~~ made of stainless steel so that deformation of the flat plate is prevented at the time of evacuation by~~with~~ such thickness.

[0031] The present invention in accordance with a seventh embodiment modifies the first embodiment as claimed in Claim 7 according to Claim 1 is so

15 ~~constituted so~~ that ~~the~~a vacuum thermal insulating pipe receiving part J installed on the side of the lower vacuum jacket S₅ is made to be a 50mm to ~~~~~150mm long cylinder-shaped vacuum jacket made of a 2mm-thick stainless steel plate, and O-rings 4a, 4b made of ~~the~~ thermal insulating material are placed on the peripheral face of one end or both ends of at~~the~~ tip part 3a of the vacuum thermal

20 insulating pipe 3 to be inserted into the~~said~~ vacuum thermal insulating pipe receiving part from the outside, and the afore-mentioned O-rings 4a, 4b made of ~~the~~ thermal insulating material are caught between the vacuum thermal insulating pipe receiving part J and the tip part 3a thereof

[0032] The present invention in accordance with an eighth embodiment

~~modifies the first embodiment as claimed in Claim 8 according to Claim 1 is so constituted so that the jointed parts 2c, 2d in the shape of a brim of the side walls of the upper and lower vacuum jackets S₄, S₅ combined in an opposite direction are pressed by a plural number of press-clips 5 with an appropriate space.~~

5 [0033] The present invention in accordance with a ninth embodiment modifies the first embodiment as claimed in Claim 9 according to Claim 1 is so

~~-11-~~

~~made so that the height of the overlapped part W₁ in with the combination with the upper and lower vacuum jackets S₄, S₅ that which forms the side wall~~
10 of the vacuum thermal insulating box S₁ is made to be more than 100mm.

[0034] The present invention in accordance with a tenth embodiment modifies the first embodiment as claimed in Claim 10 according to Claim 1 is so made so
that the inner wall face of the vacuum thermal insulating spaces 2a, 2b, 2b' of the
upper and lower vacuum jackets S₄, S₅ undergoes ~~performed the heat~~
15 treatment after plating.

Effects of the Invention

[0035] With the present invention, a vacuum thermal insulating box S is formed
by combining the upper and lower vacuum jackets S₄, S₅, and the length of the
20 overlapped part W₁ with the combination of both jackets₁ is made to be more
than approximately one half of the height (e.g., more than approximately
100mm) of the vacuum thermal insulating box S, and the thickness of the wall
material 7b, 7a' on the one part which forms the afore-mentioned overlapped
part W of both vacuum jackets S₄, S₅ is made to be thinner than the thickness of

the wall material on the other part, thus considerably enhancing the vacuum thermal insulating performance ~~considerably~~ due to ~~at~~ the substantial decrease in the solid heat transfer volume.

[0036] Also, in accordance with the present invention, a silicon sponge made thermal insulating layer K is employed so that hermeticity of the overlapped part, ~~formed by~~ with the combination of both vacuum jackets S₄, S₅, is enhanced and the solid heat transfer is reduced. ~~T~~, and thus, ~~at~~ the higher thermal insulating performance is _-

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assured due to the fact that there is no heat leakage at all from the inside of the vacuum thermal insulating box S because the box is ~~so~~ constituted such that the jointed parts 2c, 2d, 2d' are formed on the end parts of both vacuum jackets S₄, S₅.

[0037] Furthermore, there is no chance at all that the gas is condensed inside the valve unit body V₁ because the ~~due to the reason that~~ said valve unit body employed is heated with the plane heater H, thus providing ~~enabling to supply a~~ vacuum thermal insulating valve that is small and compact in size and at the lower cost.

Brief Description of the Drawings

[0038] Figure 1 is a partial cutaway front view of a vacuum thermal insulating valve in accordance with the present invention.

[0039] _____ Figure 2 is a left side view of Figure 1.

[0040] _____ Figure 3 is a right side view of Figure 1.

[0041] ————Figure 4 is a plan view of Figure 1.

[0042] ————Figure 5 is a perspective view of a vacuum thermal insulating box ~~that~~^{which} forms a vacuum thermal insulating valve in accordance with the present invention.

5 [0043] ————Figure 6 is a partially enlarged perspective view of the part with the combination of a lower vacuum thermal insulating jacket and an upper vacuum thermal insulating jacket.

[0044] ————Figure 7 is a partially enlarged perspective view showing the jointed part of a joint of the lower vacuum thermal insulating jacket and a vacuum
10 thermal insulating pipe.

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[0045] Figure 8 shows the positions of measuring points in the thermal insulating performance test of the vacuum thermal insulating valve in accordance with the present invention (a front view).

15 [0046] ————Figure 9 shows the positions of measuring points in the thermal insulating performance test of the vacuum thermal insulating valve in accordance with the present invention (a left side view).

[0047] ————Figure 10 shows the positions of measuring points in the thermal insulating performance test of the vacuum thermal insulating valve in
20 accordance with the present invention (a plan view).

[0048] ————Figure 11 shows the positions of measuring points in the thermal insulating performance test of the vacuum thermal insulating valve in accordance with the present invention (a left side view).

[0049] ————Figure 12 is a curve ~~to showing~~^{showing} the temperature distribution of

the measuring points when the temperature of the valve unit body V₁ is made to be 150°C.

[0050] ———— Figure 13 is a diagram ~~to showing~~ the relationship between the temperature of measuring points and the distance from the jointed parts of the jacket (i.e., an upper jacket).

[0051] ———— Figure 14 is a diagram ~~to showing~~ the relationship between the temperature of measuring points and distance from the jointed parts of the jacket (i.e., a lower jacket).

[0052] ———— Figure 15 is a cross-sectional view ~~to showing~~ the jointed part of the upper jacket and the lower jacket.

[0053] ———— Figure 16 is a partial cross-sectional view to show another example of _—

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the joint.

[0054] ———— Figure 17 is a front view ~~of to show~~ an example of a unit valve that which forms the present invention.

[0055] ———— Figure 18 is a block diagram of the flow passage in Figure 17.

[0056] ———— Figure 19 is a front view ~~to showing~~ another example of a unit valve that which forms the present invention.

[0057] ———— Figure 20 is a block diagram of the flow passage in Figure 19.

[0058] ———— Figure 21 is a perspective view ~~of to show~~ an example of a vacuum thermal insulating box.

[0059] ———— Figure 22 is a front view of the vacuum thermal insulating box that which is formed of 3 vacuum jackets.

[0060] _____Figure 23 is a left side view of the vacuum thermal insulating box shown in Figure 22.

5 [0061] _____Figure 24 is a plan view of the vacuum thermal insulating box shown in Figure 22.

[0062] _____Figure 25 is a drawing ~~to-showing~~ the measuring points of the vacuum thermal insulating box shown in Figure 22.

10 [0063] _____Figure 26 is a diagram ~~to-showing~~ the relationship between the temperature of the measuring points of the vacuum thermal insulating box and the distance from the inner wall face shown in Figure 22. (No.1 vacuum jacket)

[0064] _____Figure 27 is a diagram ~~to-showing~~ the relationship between the temperature of the measuring points of the vacuum thermal insulating box and the distance from _-

-15-

15 the inner wall face shown in Figure 22. (No.2 vacuum jacket)

List of Reference Characters and Numerals

[006539] V Valve

V₁ Valve unit body

20 V₁₀ Valve body

V₂₀ Valve body

V_{n0} Valve body

D Actuator

S Vacuum thermal insulating box

	S ₁	No.1 vacuum jacket
	S ₂	No.2 vacuum jacket
	S ₃	No.3 vacuum jacket
	S ₄	Upper vacuum jacket
5	S ₅	Lower vacuum jacket
	W	Overlapped part <u>of</u> with the combination of the upper and lower vacuum jackets
	J	Vacuum thermal insulating pipe receiving part
	K	Silicon sponge made thermal insulating material layer
10	H	Heater
	G	Getter case
	O	Shut-off valve
	Q	Cable takeout opening
	-16-	
15	OUT ₁ →IN	Temperature measuring points
	1	Vacuum thermal insulating valve
	2a, 2b, 2b'	Vacuum thermal insulating spaces
	2c	Jointed part of the lower end part of the upper vacuum jacket
	2d	Jointed part of the outer wall of the lower vacuum jacket
20	2d'	Jointed part of the upper end part of the lower vacuum jacket
	2e ₁ →2f	Welded part
	3	Vacuum thermal insulating pipe
	3a	Tip part
	3b ₁ →3c	Step parts

4a, 4b Thermal insulating material made O-ring

5 Press clip

6 Pipe heater

7a Outer wall of the upper vacuum jacket

5 7b Inner wall of the upper vacuum jacket

8a Outer wall of the lower vacuum jacket

8a' Outer wall above from the center part of the lower vacuum jacket

8b Inner wall of the lower vacuum jacket

9 Metal pipe

10 10 Pipe fitting

Detailed Description of Best Mode of Carrying Out the Invention

[006640] The following embodiments in accordance with the present invention,

~~17~~

15 are described with reference to the drawings as follows hereunder.

Figure 1 is a partial cutaway front view of a vacuum thermal insulating valve in accordance with the present invention. Figure 2 is its left side view, Figure 3 is its right side view, and Figure 4 is its plan view. Figure 5 is a perspective view of a vacuum thermal insulating box S in accordance with which
20 ~~constitutes~~ the present invention.

[006741] Referring to Figure 1 to Figure 5, a vacuum thermal insulating valve 1, in accordance with the present invention, comprises a valve V and a vacuum thermal Insulating box S that~~which~~ surrounds the valve V.

The afore-mentioned valve V comprises a valve unit body V₁ and a

plural number of actuators D and heaters. Furthermore, the vacuum thermal insulating box S comprises an upper vacuum jacket S4 and a lower vacuum jacket S5.

5 Embodiment 1

[006842] As shown in Figure 15 and Figure 17, the afore-mentioned valve V comprises a valve unit body V1 that is formed by connecting, removably and integrally, with a plurality-number of valve bodies V10, V20, V30, and actuators D, D...and the like fixed to the valve bodies V10, V20, Vn0. A metal made diaphragm-type valve, which ~~is~~has been already known, has been often employed for the fore-mentioned valve bodies V10, V20. Furthermore, a pneumatically operated cylinder, or an electrically operated driving mechanism, have been well-employed for actuators D, C....--

~~-18-~~

15 Detailed explanation on ~~the~~said valve V is thus omitted herewith because ~~its structure is~~ has been well known. Valve seats and valve seat parts of the valve bodies V10, V20, which are used with the present invention, are positioned on inner sides of the valve bodies V10, V20 so that they can be easily heated by the heater H.

20 [006943] A vacuum thermal insulating box S is formed by combining and fixing an upper vacuum jacket S4 and a lower vacuum jacket S5. SpecificallyNamely, as shown in Figure 6, the upper vacuum jacket S4 and the lower vacuum jacket S5 are formed by combining a 1.5mm thick stainless steel plate 7b, 8a' and a 2.0mm thick stainless steel plate 8a, 8b in the shape of a dual wall. The

vacuum thermal insulating space 2a (with ~~an~~the approximately 4.5mm clearance) of the upper vacuum jacket S₄ is held at a degree of vacuum of approximately 10^{-2} ~~to~~ 10^{-4} ~~-torr~~. A degree of vacuum less than 10^{-4} ~~-torr~~ under high temperature is held by a getter.

5 [007044] The clearance of the vacuum layer 2b of the lower part of the lower vacuum jacket S₅ is made to be 13mm. The part W to which the upper vacuum jacket S₄ fits (i.e., the combined and overlapped part W of the upper and lower vacuum jackets S₄, S₅) has with the vacuum layer 2b' ~~with a~~ space distance of approximately 4.5mm.

10 The height (that is, the heat transfer distance) of the fitted part (i.e., the combined and overlapped part W) of both vacuum jackets S₄, S₅, which constitutes the part affected by the heat transfer, is made to be approximately 100mm.

[007145] More ~~specifically~~concretely, the outer wall 7a of the upper vacuum jacket S₄ is made to be 2mm thick and the inner wall 7b is 1.5mm thick, for which a stainless

~~10~~

steel plate is used.

 On the other hand, the lower part (including the bottom face) of the
20 outer wall 7b of the lower vacuum jacket S₅ is made to be 2mm thick and the inner wall 8b is 2mm thick, and the upper side wall (the overlapped part W) 8a' of the outer wall 8b is 1.5mm thick, for which a stainless steel plate is used.

[007246] A getter case G and a shut-off valve O are mounted on the afore-mentioned upper vacuum jacket S₄ and lower vacuum jacket S₅.

respectively. Furthermore, the former is equipped with a takeout opening Q for a cable and a valve driving air pipe, while the latter is equipped with a vacuum thermal insulating pipe receiving part (i.e., a joint) J for connecting a vacuum thermal insulating pipe (not illustrated).

5 [007347] The inner wall 7b and outer wall 7b₁ which form the lower end part of the afore-mentioned upper vacuum jacket S₄ are bent toward the outer side in the shape of a brim, and the jointed part 2c is formed in the shape of a brim by both being jointed.____

____Similarly, the inner and outer walls 8b, 8a₁ which form the upper end
10 part of the lower vacuum jacket S₅ are bent toward the inner side, and the jointed part 2d' is formed in the shape of a brim.____

____Furthermore, on the center part of the side wall of the lower vacuum jacket S₅, there is formed a jointed part 2d ~~that~~which is extruded toward the outside by bending the lower end part of the outer wall 8a' and the upper end
15 part of the outer wall 8a toward the outside, respectively, and overlapping them.

[007448] The afore-mentioned end faces of the brim-shaped jointed parts 2c, 2d,

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2d' extruded toward the outside are welded to make the welded parts 2e, 2f, thus
20 being hermetically fixed.____

____Furthermore, as shown in Figure 6, a silicon sponge-made thermal insulating material layer K is provided infor the clearances made between the inner wall 7b of the vacuum jacket S₄ and the jointed part 2d', and also between the jointed parts 2d, 2c ofwhen both vacuum jackets S₄, S₅. T, thus, the

hermeticity between both vacuum jackets S₄, S₅ ~~is being~~ secured and the solid heat transfer ~~is being~~ prevented.

[007549] A 1.2mm thick stainless steel plate is used for the vacuum thermal insulating pipe receiving part J₁ mounted on the side of the afore-mentioned lower vacuum jacket S₅, to form a so-called Bionett joint type vacuum thermal insulating part as constituted in Figure 7. __

~~Specifically~~ Namely, it is ~~so~~ constituted so that the receiving part J and the vacuum thermal insulating pipe 3 are hermitically connected in a the manner so that the part 3a₁ having with a smaller diameter a ~~so~~ of the tip of the vacuum thermal insulating pipe 3₁ is inserted therein, and the tip face of the receiving part J and the step part 3b of the part 3a₁ which has with a small diameter a ~~so~~ of the tip of the vacuum thermal insulating pipe 3₁ are contacted through the mediation of a the thermal insulating material made ring 4a. The length of the receiving part J is made to be approximately 100mm.

[007650] ~~In~~ With Figure 7, 6 designates a heater, 9 a metal pipe, and 10 a pipe joint. __

~~Detailed~~ explanation on the structure of the said vacuum thermal insulating pipe receiving part J, pipe joint 10₁ and the like₁ is omitted herewith because they are well known.

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[007754] Next, the thermal insulating characteristics test performed on the thermal insulating valve 1₁ in accordance with the present invention₁ and the test its results are described. __

~~First~~, as shown in Figure 8 to Figure 11, a 5-gang type valve (a unit

valve) V is housed in a vacuum thermal insulating box S of the breadth of approximately 400mm, the height of approximately 190mm, the depth of approximately 180mm, and the length of the receiving part J is approximately 100mm and the height of the overlapped part W of the upper and lower vacuum jackets S₄, S₅ is approximately 100mm, and a plane heater H of 400W (200W x 2) is fixed to the valve unit body V₁, and temperature measuring sensors (manufactured by OKAZAKI SEISAKUSHO CO., LTD.) are installed at the positions IN and OUT as shown in Figure 8 to Figure 11.

[007852] Next, the voltage determined by the actual measurement beforehand, which raises the temperature of the valve unit body V₁ approximately to 150°C, was applied to the plane heater H, to find the relationship between the time of the temperature sensors reading and the detected temperature.

[007953] The results are as shown in Figure 12. It has been learned that with a room temperature of approximately 26.3°C, the temperature (OUT-6 points) of the upper face side of the upper vacuum jacket S₄ may rise only to 34.3°C, and the temperature (OUT-8 points) of the side of the lower vacuum jacket S₅ may rise only to 44.7°C.

[008054] Next, the temperature of the valve unit body V₁ was stabilized to 150°C, and then, under this stabilized condition, the temperature of temperature measuring points (OUT) of the outside of the upper vacuum jacket S₄ and the lower vacuum jacket ket-

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S₅ was measured.

—The results are shown in Figure 13 and Figure 14, which show the

relationship between the afore-mentioned measurement values and the distances from the overlapped part (the jointed part) W of both vacuum jackets S₄, S₅.

[008155] In the case where the said 2-way split type vacuum thermal insulating

5 box S shown in Figure 1 to Figure 4 is employed, the input power required to keep the valve unit body V₁ heated to 150°C was determined by the input voltage adjusting method. Two plane heaters of 200W (100V · 50 Ω) x 2 for the valve unit body V₁ were employed. According to the test results, the valve unit body V₁ was held at 150°C with the input voltage of 37V. Accordingly, in this
10 case, the input was $(37^2 / 50) \times 2 = 54.8\text{W}$: (the input was 213W when a vacuum thermal insulating box was not employed). It is found that the vacuum thermal insulating performance is remarkably enhanced compareding to with the input power of 81W in the case of the afore-mentioned 3-way split type vacuum thermal insulating box S shown in Figure 22 to Figure 25.

15

Embodiment 2

[008256] Figure 15 shows another embodiment in accordance with the present invention. This secondWith said embodiment 2, it is so-constituted so that the upper and lower vacuum thermal insulating jackets S₄, S₅ are combined and
20 fitted, and then their jointed parts 2c, 2d₁ in the shape of a brim₁ are pressed by the cross sectional u-shaped clip 5 through the mediation of the thermal insulating material layer K. Hermeticity of both jackets is enhanced by pressing brim-shaped jointed parts_—

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2c, 2d with an appropriate distance, using the said clip 5 to press; thus, consumption power to hold the afore-mentioned valve unit body V₁ to 150°C is being reduced from 54.8W to 43.0W. This enhancement has been verified through the experiment.

5

Embodiment 3

[008367] Figure 16 further shows ~~further~~ another embodiment in accordance with the present invention. This third embodiment is ~~so~~ constituted so that the tip part of the part 3a, provided with a smaller diameter of the vacuum thermal
10 insulating pipe 3 for insertion ~~to be inserted~~ into the receiving part J₁ is equipped with a step part 3c, to which a silicon rubber-made O-ring 4b is fitted. —

—— By achieving this construction ~~said constitution~~, hermeticity between the tip part 3a of the vacuum thermal insulating pipe 3 and the inner wall face of the joint J is enhanced. Heat leakage inside the vacuum thermal insulating box S₁
15 toward the outside, is shut out at the heat source side, thus resulting in further improvements in the thermal insulating performance.

[008458] The reason why a silicon rubber made sponge is employed as for the afore-mentioned thermal insulating material layer K₁ or that a silicon rubber made thermal insulating material is used for the thermal insulating O-rings 4a, 4b,
20 in accordance with the present invention is because they have both high heat resistance and excellent hermeticity. For ~~With~~ this ~~these~~ embodiment, the product made with the low polymer resin, Siloxane by SHINETSU POLYMER CO., LTD., is ~~is~~ employed.

Feasibility of Industrial Use

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[008559] A vacuum thermal insulating valve, in accordance with the present invention, is mainly utilized with the pipes in the gas supply systems or vacuum

5 exhaust systems with semiconductor manufacturing facilities or plasma generating apparatuses. However, the present invention is not limited to the afore-mentioned semiconductor manufacturing facilities and the like, but also may be utilized as the constituent components for the gas supply systems or the gas exhaust systems used in chemical, pharmaceutical or food-processing

10 industries and the like.